Total No. of Questions: 4



Enrollment No. EN RICS 304058

Faculty of Engineering Mid Sem I Examination April -2022 EN3ES16 Basic Electronics Engineering

Programme: B.Tech.Branch/Specialisation: All

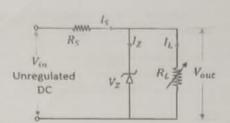
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2-7-1	200	960		 Hr
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Dur	ation:	2 Hrs. Maximum Marks:	aximum Marks: 40	
Q.1	1.	Zener breakdown occurs	1	
		Mostly in germanium junctions		
		Due to rapture of covalent bonds		
		3. In lightly doped junctions		
	ii.	4. Due to thermally generated minority carriers		
	11.	A clipper circuit always	1	
		Needs a DC source Cline both helf make a finant signal		
		Clips both half cycles of input signal Clips upper portion of the signal		
		Clips some part of the input signal		
	iii.	For the BJT's saturation region of operation, the input and output	1	
	111.	iunctions should be connected as -		
		Forward biased & Reverse biased		
		Forward biased & Forward biased		
		Reverse biased & Reverse biased		
		Reverse biased & Forward biased		
	iv.	Transistor current gain β can be expressed in terms of α as-	1	
	***	1. a/(1+a)		
		2. a/(1-a)		
		3. (1+a)/a		
		4. (1-a)/a		
	- 44	A zener diode	1	
	V.	Has a high forward voltage rating		
		Has a sharp breakdown at low reverse voltage		
		3 Is useful as an amplifier		
		The second secon		
	vi.	4. Has a negative resistance The current direction is always shown on which terminal of BJT in its	1	
	41.	electronic symbol		
		1. Base		
		2 Emmiter		
		3. Collector		
		4 Base and Collector both		

	vii.	The depletion region in an open circuited PN junction contains 1. Electrons	1
		Holes Uncovered immobile impurity ions	
		Neutralized impurity atoms	
	viii.		1
		1. Power	
		2. Current	
		3. Voltage	
		4. Energy	
	ix.	In the term of heavy doping and larger area, which one is correct for the	1
		BJT transistor	
		Base and Collector	
		2. Emitter and Base	
		3. Collector and Emitter	
		Emitter and Collector	
	X.	Avalanche breakdown is primarily dependent on the phenomenon of	1
		1. Collision	
		2. Doping	
		3. Ionizing	
		4. Recombination	
0.2	i.	How Depletion layer forms in PN Junction diode?	2
	ii.	Explain half wave rectifier with diagram and input/output waveforms.	3
		Write the expression of ripple factor and efficiency.	
	iii.	How current made to flow in n-Channel JFET? Explain full working	5
	111.	functionality of JFET along with current equation.	
On	Ø.,	Explain Common Base Configurations with input and output V-1	5
OR	iv.	characteristic, also explain its Current amplification gain.	3
Q.3	i.	Write any two basic differences between JFET and MOSFET.	2
-	ii.	D. 1 3310	.8
		- N - 12 - W	
		R,	
		11 [†] 11 [†]	
		E=20V - D ₂	
		R,	
		L-Minet -	
		5.61Ω	
		For the circuit shown above, Find the value of current l ₁ , l ₂ and l ₃ .	
		Diodes connected in circuit are silicon diodes and having internal	

resistances are zero (Simplified model).





For a Zener shunt regulator shown if figure, if $V_z=20 \text{ V}$, $R_s=20\text{k}\Omega$, $R_L=$ $5.5k\Omega$ and the input voltage varies from 32 to 48 V, Find the maximum and minimum values of Zener current.

- Q.4 Explain diode current equation in both forward and reverse biasing. ii.
- 3 What is Bridge Rectifier? Explain with diagram and input/output waveforms. Give expression of ripple factor, efficiency and PIV.
- OR iii. For a silicon diode the reverse saturation current is 2.5 µA at the temperature of 300 K, What could be the forward voltage value if forward current of 10 mA is flowing through the diode?